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Dimensions

Chip Size	0805
L	2.03mm +/-0.38mm (0.08 in +/-0.015 in)
W	1.27mm +/-0.38mm (0.05 in +/-0.015 in)
T	0.98mm +/-0.42mm (0.039 in +/-0.017 in)
B	0.51mm +/-0.25mm (0.02 in +/-0.01 in)

Packaging Specifications

Packaging	Bulk, Anti-Static Bag
Packaging Quantity	1

General Information

Series	SMD Mil PRF55681
Style	SMD Chip
RoHS	No
Prop 65	⚠ WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov .
Termination	Lead (SnPb)
Failure Rate	R (0.01%/1000 Hrs)
Testing and Reliability	MIL-PRF-55681
Qualifications	MIL-PRF-55681
AEC-Q200	No
Miscellaneous	Termination Description: SolderPlate 70-30.
Shelf Life	78 Weeks
MSL	1

Specifications

Capacitance	470 pF
Capacitance Tolerance	20%
Voltage DC	100 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	BX

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